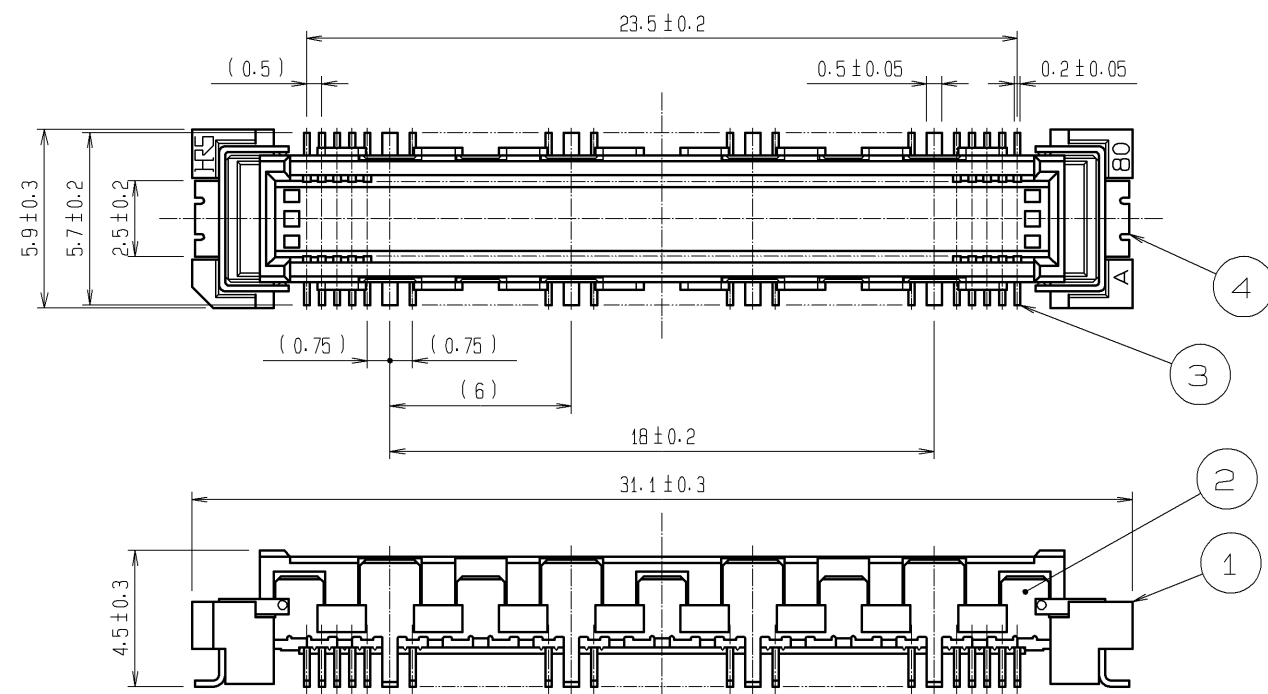
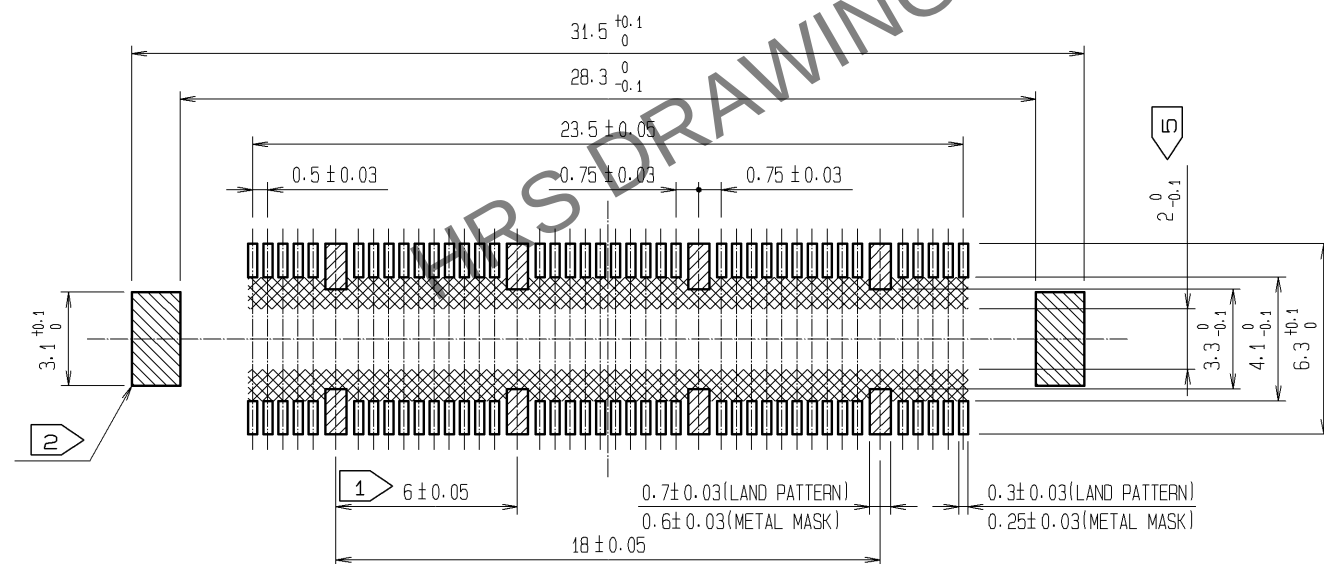


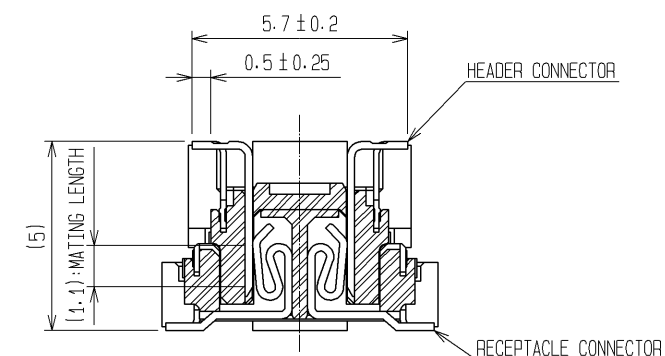


RECOMMENDED LAND PATTERN DIMENSION OF PCB

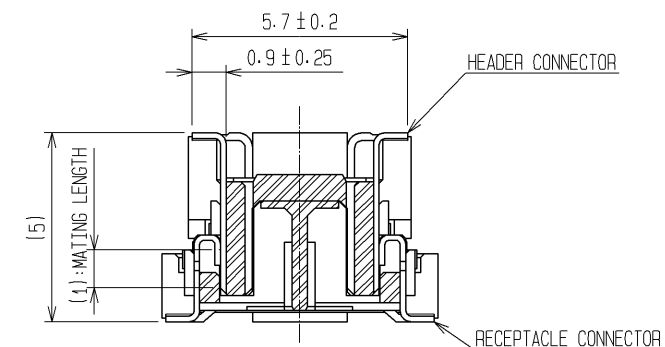


- NOTES
- 8 HATCHED PARTS: GROUND CIRCUIT.
 - 2 HATCHED PARTS: GROUND CIRCUIT.
 - SMT LEAD-COPLANARITY: 0.1 MAX.
 - THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

CROSS CUT SECTION - SIGNAL (5:1)



CROSS CUT SECTION - GROUND (5:1)



2	PHOSPHOR BRONZE	TIN-PLATING	4	PHOSPHOR BRONZE	TIN-PLATING
1	LCP	BEIGE UL94V-0	3	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1μm min. LEAD AREA: TIN-PLATING 1μm min. UNDER PLATING: NICKEL 1μm min.
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
UNITS mm		SCALE 4 : 1	COUNT △	DESCRIPTION OF REVISIONS	DESIGNED CHECKED DATE
HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA	07.10.15	DRAWING NO.	EDC3-151964-25
		CHECKED : HS. OZAWA	07.10.15	PART NO.	FX10B-80P/8-SV1(71)
		DESIGNED : SY. KAMIGA	07.10.15	CODE NO.	CL570-0121-7-71
		DRAWN : HK. SUNADORI	07.10.12		